## mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

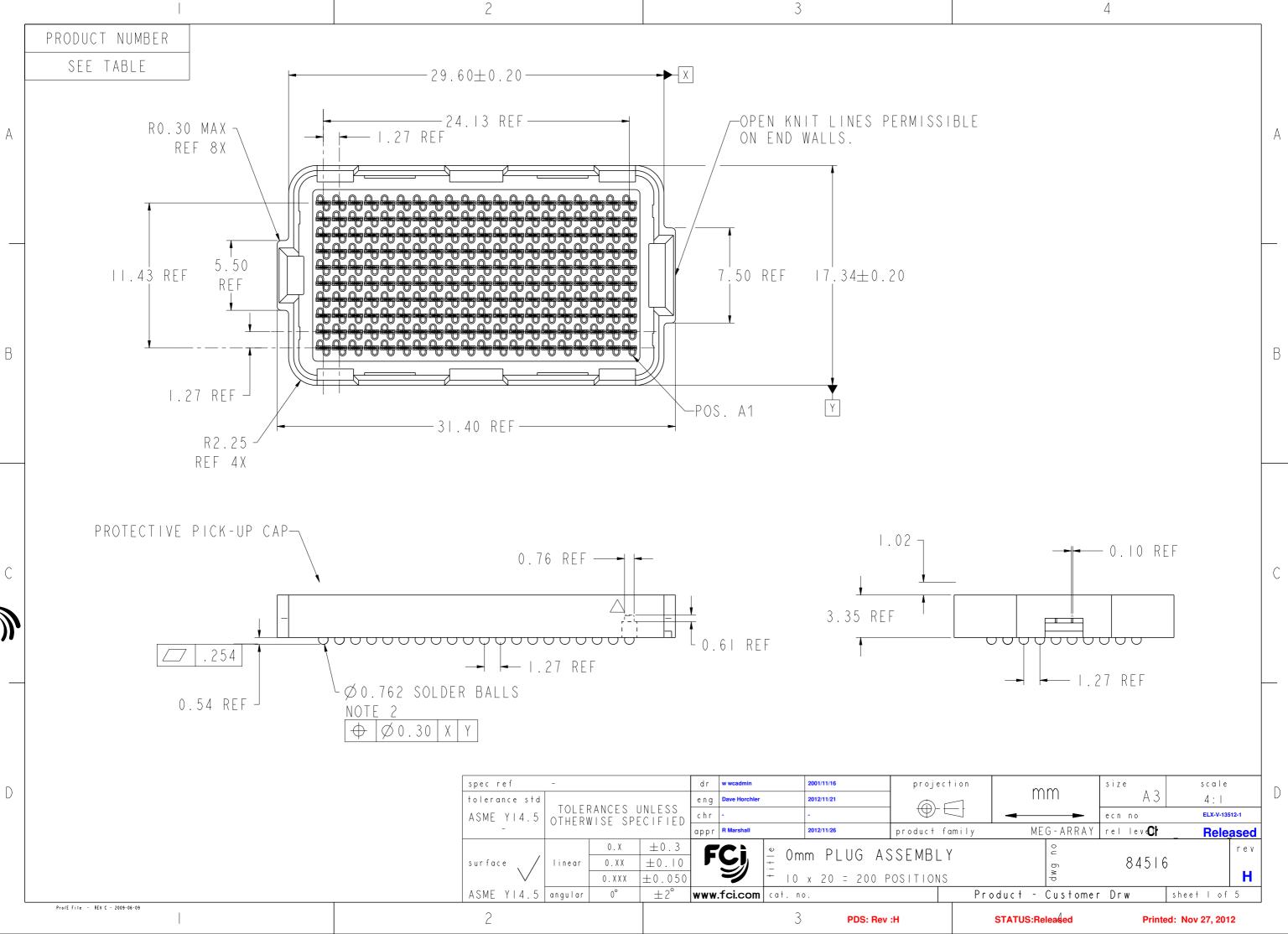
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



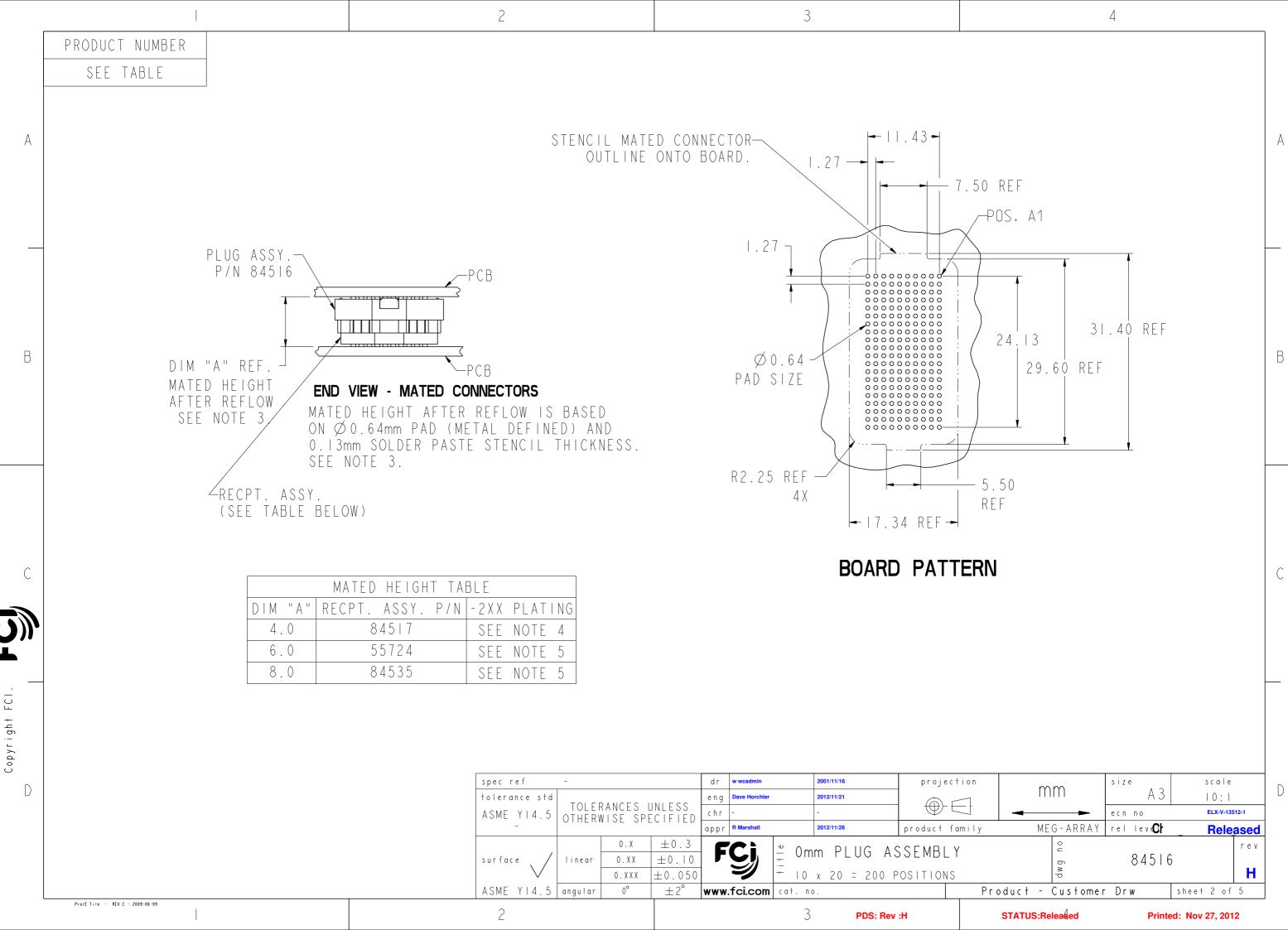
## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





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	PRODUCT NUMBER				
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			ASME YI4.5 TOLERANCE OTHERWISE	SUNLESS SPECIFIED Appr R Marshall 2012/11/26 product for	$\neg$
			surface Linear 0.X	$\times$ ±0.10 <b>FG</b> = 0mm PLUG ASSEMBLY	'
			ASME YI4.5 angular 0°	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	P
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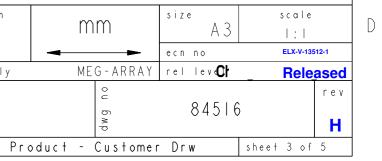
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CONNECTOR

POS. A1

## DE-REEL DIRECTION

REA FOR PICK-UP CAP.



STATUS:Released

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PDS: Rev :H

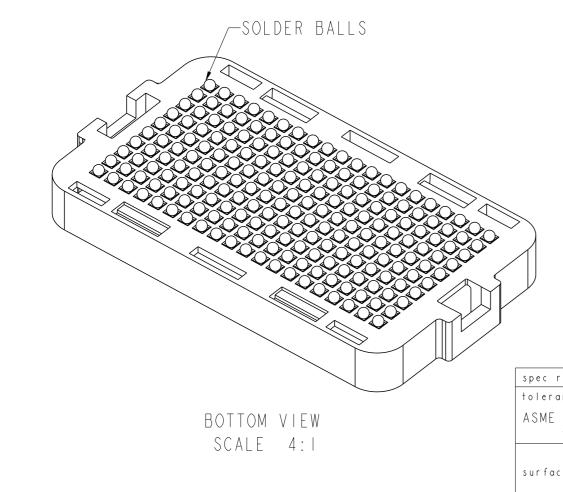
Printed: Nov 27, 2012

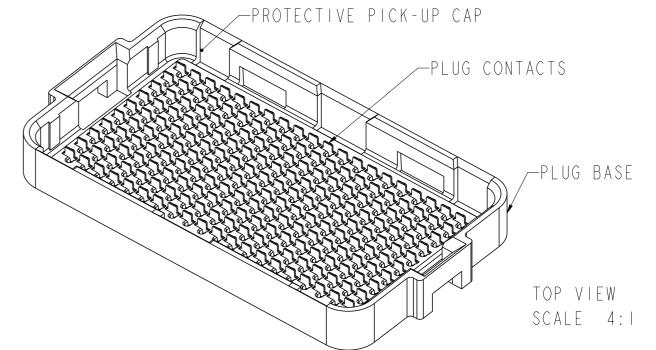
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	PRODUCT NUMBER (NA	PICK-UP CAP TURAL OR BLACK COL	OR) CONTACT PLATING AND THICK	NESS SOLDER BALL	NOTES
	84516-002	YES	5μ" / (.38μm) Au	SnPb	9
A	84516-002LF	YES	5μ" / (.38μm) Au	LEAD FREE	7 AND 9
	84516-092	YES	Ι5μ" / (.38μm) GXT		
	84516-092LF	Y E S	Ι5μ" / (.38μm) GXT		
	84516-102	YES	30µ" / (.76µm) Au	SnPb	9
	84516-102LF	YES	30µ" / (.76µm) Au	LEAD FREE	7 AND 9
	84516-192	YES	30µ" / (.76µm) GXT	SnPb	4, 5 AND 9
	84516-192LF	YES	30µ" / (.76µm) GXT		
	845   6 - 202	YES	50μ" / (Ι.27μm) Au SPECIAL	L	
	84516-202LF	YES	50μ" / (Ι.27μm) Au SPECIAL	L LEAD FREE	4, 5, 7 AND 9
	84516-292	YES	50µ" / (І.27µm) GXT SPECIA	L	
	84516-292LF	Y E S	50µ" / (І.27µm) GXT SPECIA	L	
	845I6-A02	YES	30µ" / (.76µm) SPECIAL	SnPb	8
	84516-A02LF	YES	30µ" / (.76µm) SPECIAL	LEAD FREE	7 AND 8
В	<u> </u>	YES		. SnPb	8
		YES		LEAD FREE	7 AND 8-
	84516-402	YES	<u> 30µ" / (.76µm) Au SPECIAL</u>	. SnPb	
		YES	<u> 30µ" / (.76µm) Au SPECIAL</u>	LEAD FREE	7 AND 8
		YES	Au SPECIAL	SnPb	4, 5 AND 8
		YES	Au SPECIAL	LEAD FREE	4, 5, 7 AND 8





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ASME YI4.5	angular	0°	±2°	www	.fci.com	cat.no	).		Pro	oduct -	Customer	Drw	sheet 4 of	5	
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	PRODUCT NUMBER				I				
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A									
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	95.5Sn/4Ag/0					MEETI	NG THIS DIREC	CTIVE IS ID	DENT
В	(2.) SOLDER BALLS WILL NOT BE SPHERICAL SHAPE DUE TO RE	FLOW					R MARKED ON E CTER POSITION		3Y H/
	ATTACHMENT.				1	8.) 84516	-A02 AND -A02	PLF PLATING	) IS
	(3.) MATED HEIGHT EFFECTED BY PCB PAD SIZE, PLATING, SO PROFILE & SOLDER PASTE.	LDER REFLOW							
	(4.) PLATING FOR INDICATED -2X	V SEDIES DDANIAT				(0) A $G$	SYMBOL WILL B	BE NEXT TO	ANY
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